## Minutes from OpenPICs WP 4 meeting 29-05-2017

Present: Longfei, Rui, Rob, Roel, Tjibbe, Rene, Robert, Weiming

## **Discussion/action points**

Nr.	Description	Responsible
1.	Al-MQW	
	The design will be ready in 1-2 weeks.	Weiming,
	The Al-Q will be calibrated in both Nanolab and Smart reactors.	Longfei
2.	Zn diffusion tests	
	<ul> <li>Get an empirical model based on more data points with the standard MPW layerstack.</li> </ul>	Rene
	• Quick diffusion test on a SiNx mask covered sample to check particles.	
	• 4 samples will be shipped to UK for SIMS measurement.	
	<ul> <li>Test with mask opening. Longfei will follow up on the design.</li> </ul>	Longfei
3.	BCB planarization	
	• Planarization test has been done on the sample from Smart. Tjibbe is waiting	Tjibbe
	for Tencor to be operational for the measurement.	
	• Lithography parameters have to be re-optimized for BCB.	
4.	Stepper process	
	• FEM tests with AZ resist will be done in 1-2 weeks.	Robert
5.	Etching process	
	<ul> <li>The new CH4-H2 recipe (optimized for ~3 degree side-wall angle in Smart's</li> </ul>	Rui
	ICP) will be transferred to Nanolab after a few more fine-tuning.	_
	• 2 Cl2-CH4-H2 recipes were tested, giving etch rates of 360 (@60C) and 250	Longfei
	(@200C) nm/min. No influence to the reactor is observed. Oxford has been	
	contacted for suggestions of the next plans.	
6.	Planning and milestone list	_
	The milestone list with quantified criteria has been sent around. Each	Everyone
	responsible person should check their own items.	
	Upcoming due dates for milestones:	
	M 3.1 (end June) Zn-diffusion time determined: ready for joint MPW validation.	Rene
	M 5.1 (end June) DUV lithography introduced to MPW.	Smart

Next meeting: 13:30-15:00, 12-6-2017, Flux 10.177